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STFU16N65M2

N-channel 650 V, 0.32 Ω typ., 11 A MDmesh™ M2 Power MOSFET in a TO-220FP ultra narrow leads package

Datasheet - production data

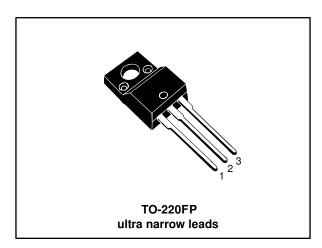
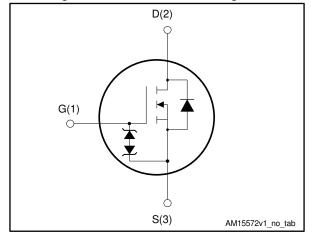


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max	ID
STFU16N65M2	650 V	0.36 Ω	11 A

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

Table 1: Device summary

Order code	Marking	Package	Packaging
STFU16N65M2	16N65M2	TO-220FP ultra narrow leads	Tube

Contents STFU16N65M2

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STFU16N65M2 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 25	V
I _D	Drain current (continuous) at T _C = 25 °C	11 ⁽¹⁾	Α
ΙD	Drain current (continuous) at T _C = 100 °C	6.9 ⁽¹⁾	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	44 ⁽¹⁾	Α
P _{TOT}	Total dissipation at $T_C = 25$ °C	25	W
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T_C = 25 °C)	2500	>
dv/dt (3)	Peak diode recovery voltage slope	15	\//no
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature range	EE to 150	°C
Tj	Operating junction temperature range	-55 to 150	10

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	5	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	Avalanche current, repetitive or not repetitive (pulse width limited by T _{jmax})	1.9	Α
Eas	Single pulse avalanche energy (starting $T_j = 25^{\circ}C$, $I_D = I_{AR}$; $V_{DD} = 50 \text{ V}$)	360	mJ

⁽¹⁾Limited by maximum junction temperature..

⁽²⁾Pulse width limited by safe operating area.

 $^{^{(3)}}I_{SD} \leq$ 11 A, di/dt \leq 400 A/ μ s; VDSpeak < V(BR)DSS, VDD=400 V

 $^{^{(4)}}V_{DS} \le 520 \text{ V}$

Electrical characteristics STFU16N65M2

2 Electrical characteristics

(T_C = 25 °C unless otherwise specified)

Table 5: On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0 \text{ V}$	650			٧
	Zero gate voltage	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}$			1	μΑ
IDSS	drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V},$ $T_{C} = 125 \text{ °C}^{(1)}$			100	μΑ
Igss	Gate-body leakage current	V _{DS} = 0 V, V _{GS} = ±25 V			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 5.5 A		0.32	0.36	Ω

Notes:

Table 6: Dynamic

Symbol	Parameter	Test conditions		Тур.	Max.	Unit
Ciss	Input capacitance		ı	718	-	pF
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$	1	32	-	pF
Crss	Reverse transfer capacitance	V _{GS} = 0 V		1.1	-	pF
Coss eq. (1)	Equivalent output capacitance	$V_{DS} = 0$ to 520 V, $V_{GS} = 0$ V	ı	189	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz open drain	1	5.2	-	Ω
Q_g	Total gate charge	$V_{DD} = 520 \text{ V}, I_D = 11 \text{ A},$	1	19.5	-	nC
Q _{gs}	Gate-source charge	$V_{GS} = 0$ to 10 V	-	4	-	nC
Q_{gd}	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior"	-	8.3	-	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 325 \text{ V}, I_D = 5.5 \text{ A},$	-	11.3	-	ns
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$	-	8.2	-	ns
t _{d(off)}	Turn-off delay time	(see Figure 14: "Test circuit for resistive load switching times"	ı	36	1	ns
tf	Fall time	and Figure 19: "Switching time waveform")	-	11.3	-	ns

 $[\]ensuremath{^{(1)}}\mbox{Defined}$ by design, not subject to production test.

 $^{^{(1)}}$ Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS

Table 8: Source drain diode

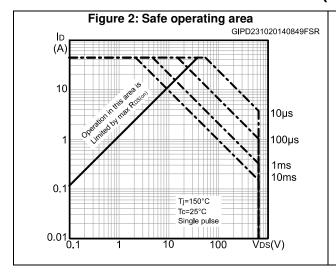
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		1		11	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		44	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 11 A, V _{GS} = 0 V	1		1.6	V
t _{rr}	Reverse recovery time	$I_{SD} = 11 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	1	342		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}$	-	3.5		μC
I _{RRM}	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	1	20.4		А
t _{rr}	Reverse recovery time	$I_{SD} = 11 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	458		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$	-	4.6		μC
I _{RRM}	Reverse recovery current	(see Figure 16: "Test circuit for inductive load switching and diode recovery times")	-	20.5		Α

Notes:

⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}\}text{Pulsed:}$ pulse duration = 300 $\mu\text{s},$ duty cycle 1.5%

2.1 Electrical characteristics (curves)



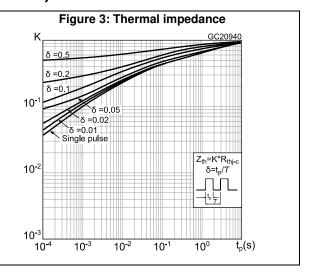


Figure 4: Output characteristics

GIPD221020141412FSR

VGS= 7, 8, 9, 10 V

24

20

16

12

5V

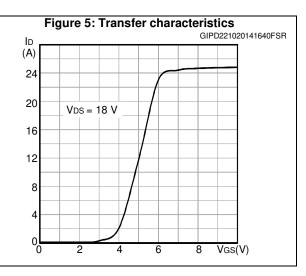
8

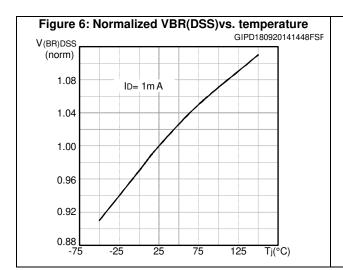
4

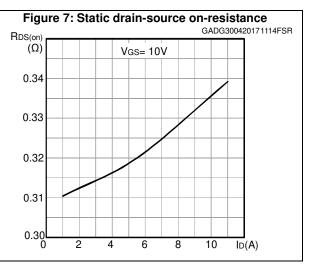
4V

0

5 10 15 VDS(V)







STFU16N65M2 Electrical characteristics

Figure 8: Gate charge vs. gate-source voltage GIPD221020141708FSR VDS (V) VDS VDD = 520 V 500 10 ID = 11 A8 400 300 6 200 100 2 0 12 16 20 Qg(nC)

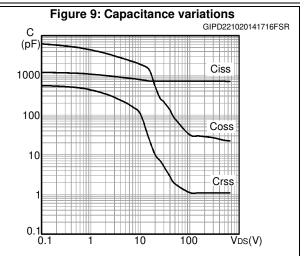
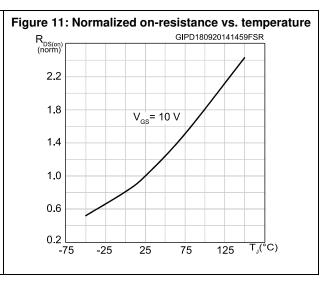
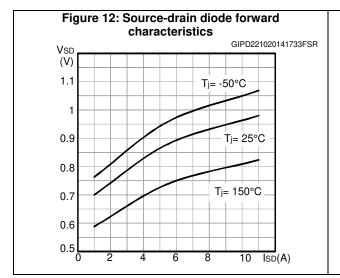
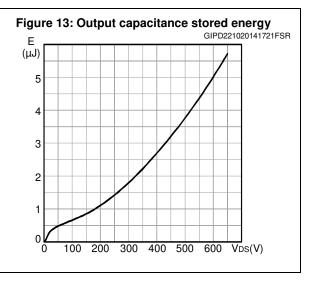


Figure 10: Normalized gate threshold voltage vs. temperature GIPD180920141442FSF VGS(th) (norm) $ID = 250 \mu A$ 1.1 1.0 0.9 8.0 0.7 0.6 **L** -75 -25 25 75 Tj(°C)







Test circuits STFU16N65M2

3 Test circuits

Figure 14: Test circuit for resistive load switching times

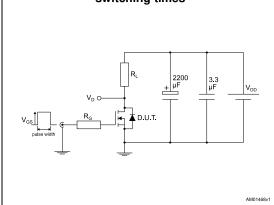


Figure 15: Test circuit for gate charge behavior

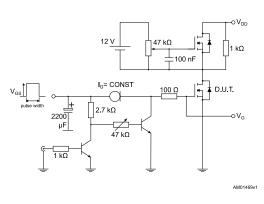


Figure 16: Test circuit for inductive load switching and diode recovery times

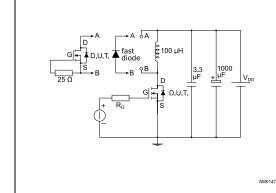


Figure 17: Unclamped inductive load test circuit

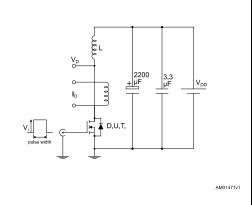


Figure 18: Unclamped inductive waveform

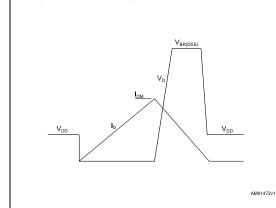
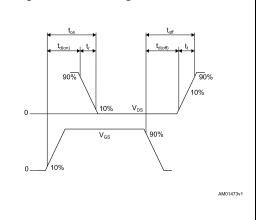


Figure 19: Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220FP ultra narrow leads package information

В F1(x3) D G1 Ε 8576148_1

Figure 20: TO-220FP ultra narrow leads package outline

Table 9: TO-220FP ultra narrow leads mechanical data

Di		mm	
Dim.	Min.	Тур.	Max.
A	4.40		4.60
В	2.50		2.70
D	2.50		2.75
Е	0.45		0.60
F	0.65		0.75
F1	-		0.90
G	4.95		5.20
G1	2.40	2.54	2.70
Н	10.00		10.40
L2	15.10		15.90
L3	28.50		30.50
L4	10.20		11.00
L5	2.50		3.10
L6	15.60		16.40
L7	9.00		9.30
L8	3.20		3.60
L9	-		1.30
Dia.	3.00		3.20

STFU16N65M2 Revision history

5 Revision history

Table 10: Document revision history

Date	Revision	Changes
03-Apr-2017	1	Initial release

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